

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BYEONGWOOK KIM	04/03/2014
HYONI KIM	04/03/2014
YOUNGHO KIM	04/03/2014
RECEIVING PARTY DATA	
Name:	LG ELECTRONICS INC.
Street Address:	128, YEOUNI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	REPUBLIC OF KOREA
Postal Code:	150-721
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29492919
CORRESPONDENCE DATA	
Fax Number:	(202)739-3001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202.739.3000
Email:	patents@morganlewis.com, ateckman@morganlewis.com
Correspondent Name:	ROBERT J. GAYBRICK
Address Line 1:	1111 PENNSYLVANIA AVE, NW
Address Line 4:	WASHINGTON, D.C. 20004
ATTORNEY DOCKET NUMBER:	001364-7318
NAME OF SUBMITTER:	ROBERT J. GOODELL
SIGNATURE:	/Robert J. Goodell/
DATE SIGNED:	06/04/2014
Total Attachments: 2	
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ASSIGNMENT

WHEREAS WE, the below named inventors, (hereinafter referred to as Assignors!), have made an invention entitled:

TABLET COMPUTER

for which WE filed an application of United States on , (Application No ; and

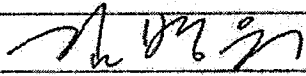

WHEREAS, LG ELECTRONICS INC., whose post office address is 128, Yeoui-daero, Yeongdeungpo-gu, Seoul, 150-721, Republic of Korea (hereinafter referred to as Assignee!), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;


AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, WE have hereunto set my hands.

Full Name of second Assignor	Byeongwook Kim
Address	c/o Seocho R&D Campus, LG Electronics Inc., 19, Yangjaedae-ro 11-gil, Seocho-gu, Seoul, Republic of Korea
Signature	
Date	April 03, 2014
Full Name of second Assignor	Hyonl Kim
Address	c/o Seocho R&D Campus, LG Electronics Inc., 19, Yangjaedae-ro 11-gil, Seocho-gu, Seoul, Republic of Korea
Signature	
Date	April 03, 2014

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Full Name of second Assignor	Youngho Kim
Address	c/o Seocho R&D Campus, LG Electronics Inc., 19, Yangjaedae-ro 11-gil, Seocho-gu, Seoul, Republic of Korea
Signature	
Date	April 03, 2014

Morgan, Lewis & Bockius LLP

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